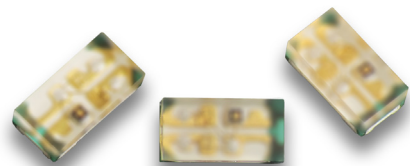


APHF1608LSEEQBDZGKC

1.6 x 0.8 mm Full-Color Surface Mount LED



DESCRIPTIONS

- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- The Blue source color devices are made with InGaN Light Emitting Diode
- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode
- Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

FEATURES

- 1.6 x 0.8 mm SMD LED, 0.5 mm thickness
- Low power consumption
- Package in 8mm tape on 7" diameter reel, 4000 pcs / reel
- Can produce any color in visible spectrum, including white light
- Moisture sensitivity level: 3
- Halogen-free
- RoHS compliant

APPLICATIONS

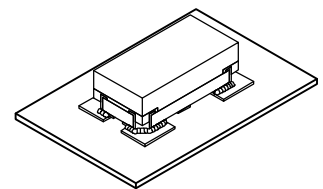
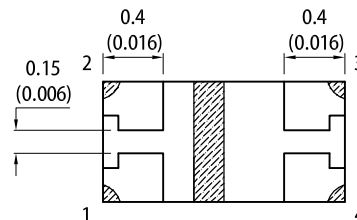
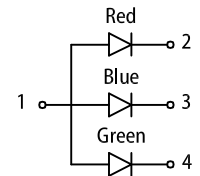
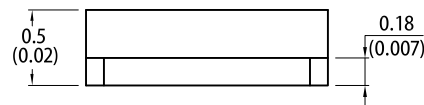
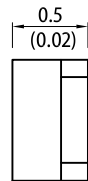
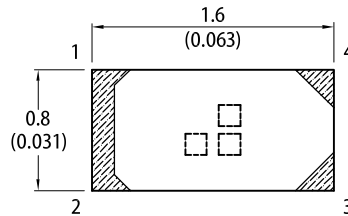
- Backlight
- Status indicator
- Home and smart appliances
- Wearable and portable devices
- Healthcare applications

ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices

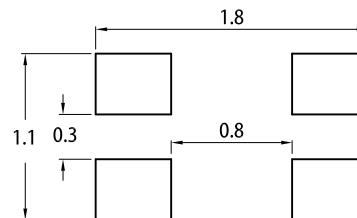


PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

(units : mm; tolerance : ± 0.1)



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.15(0.006)$ unless otherwise noted.
3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 2mA ^[2]		Viewing Angle ^[1]
			Min.	Typ.	2θ1/2
APHF1608LSEEQBDZGKC	Hyper Red (AlGaInP)	Water Clear	4	15	140°
	Blue (InGaN)		4	10	
	Green (InGaN)		50	90	

Notes:
 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
 2. Luminous intensity / luminous flux: $\pm 15\%$.
 3. Luminous intensity value is traceable to CIE127-2007 standards.

ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value		Unit
			Typ.	Max.	
Wavelength at Peak Emission I _F = 2mA	λ _{peak}	Hyper Red Blue Green	630 460 515	-	nm
Dominant Wavelength I _F = 2mA	λ _{dom} ^[1]	Hyper Red Blue Green	621 465 525	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 2mA	Δλ	Hyper Red Blue Green	20 25 35	-	nm
Capacitance	C	Hyper Red Blue Green	25 100 45	-	pF
Forward Voltage I _F = 2mA	V _F ^[2]	Hyper Red Blue Green	1.8 2.65 2.65	2.1 3.1 3.1	V
Reverse Current (V _R = 5V)	I _R	Hyper Red Blue Green	-	10 50 50	μA
Temperature Coefficient of λ _{peak} I _F = 2mA, -10°C ≤ T ≤ 85°C	TC _{λpeak}	Hyper Red Blue Green	0.13 0.04 0.05	-	nm/°C
Temperature Coefficient of λ _{dom} I _F = 2mA, -10°C ≤ T ≤ 85°C	TC _{λdom}	Hyper Red Blue Green	0.06 0.03 0.03	-	nm/°C
Temperature Coefficient of V _F I _F = 2mA, -10°C ≤ T ≤ 85°C	TC _V	Hyper Red Blue Green	-1.9 -2.9 -2.9	-	mV/°C

Notes:

1. The dominant wavelength (λ_d) above is the setup value of the sorting machine. (Tolerance λ_d : ±1nm.)
2. Forward voltage: ±0.1V.
3. Wavelength value is traceable to CIE127-2007 standards.
4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

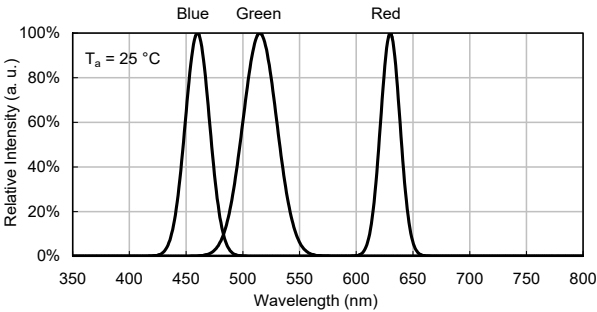
Parameter	Symbol	Value			Unit
		Hyper Red	Blue	Green	
Power Dissipation	P _D ^[1]	75	80	82	mW
Reverse Voltage	V _R	5	5	5	V
Junction Temperature	T _j	115	115	115	°C
Operating Temperature	T _{op}	-40 to +85			°C
Storage Temperature	T _{stg}	-40 to +85			°C
DC Forward Current	I _F ^[1]	30	20	20	mA
Peak Forward Current	I _{FM} ^[2]	195	100	100	mA
Electrostatic Discharge Threshold (HBM)	-	3000	250	450	V
Thermal Resistance (Junction / Ambient)	R _{th JA} ^[3]	730	720	700	°C/W
Thermal Resistance (Junction / Solder point)	R _{th JS} ^[3]	610	620	590	°C/W

Notes:

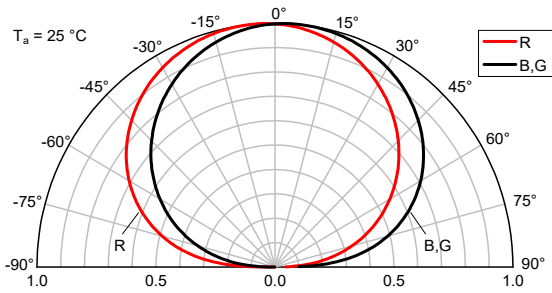
1. The maximum ratings are valid for the case of lighting a single chip
When two chips are lit at the same time, each chip should be driven at a current lower than 50% of the absolute maximum ratings
When three chips are lit at the same time, each chip should be driven at a current lower than 30% of the absolute maximum ratings
2. 1/10 Duty Cycle, 0.1ms Pulse Width.
3. R_{th JA}, R_{th JS} Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad).
4. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

TECHNICAL DATA

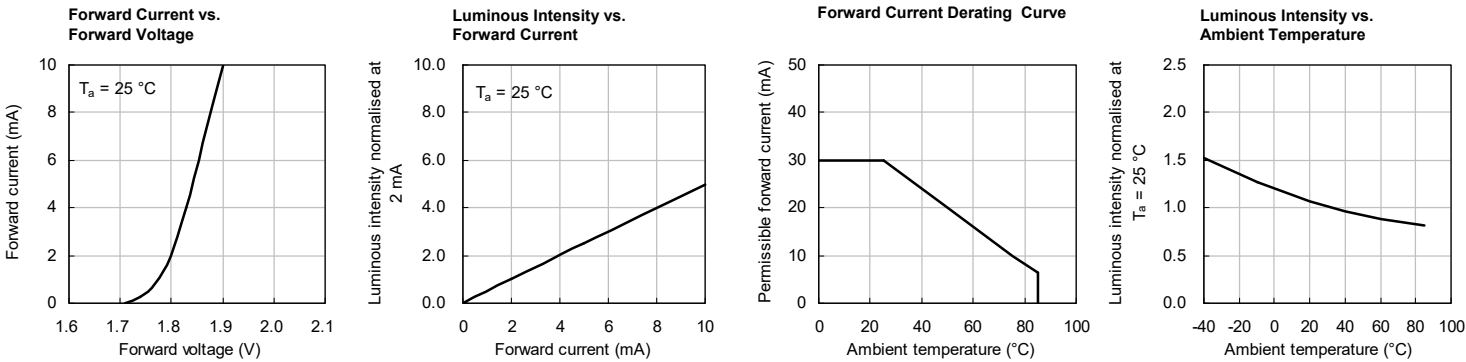
RELATIVE INTENSITY vs. WAVELENGTH



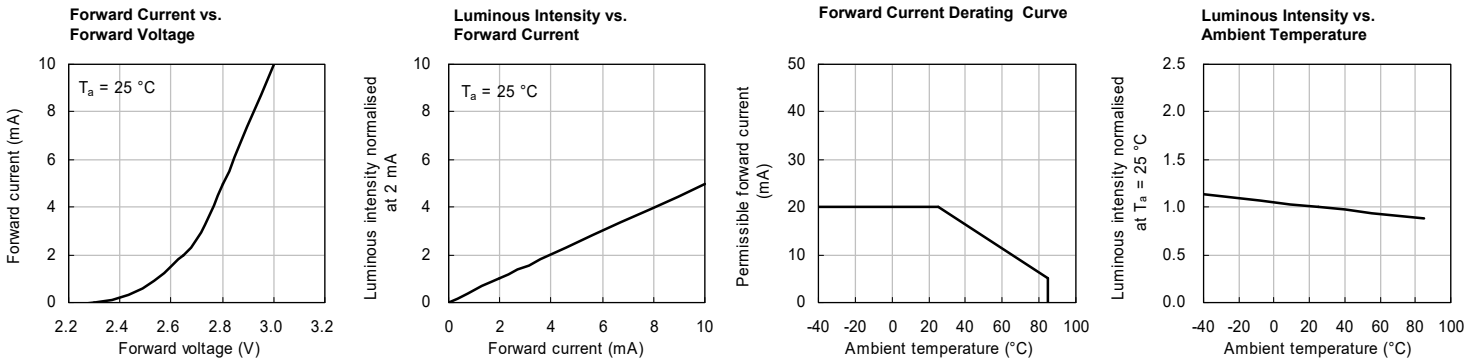
SPATIAL DISTRIBUTION



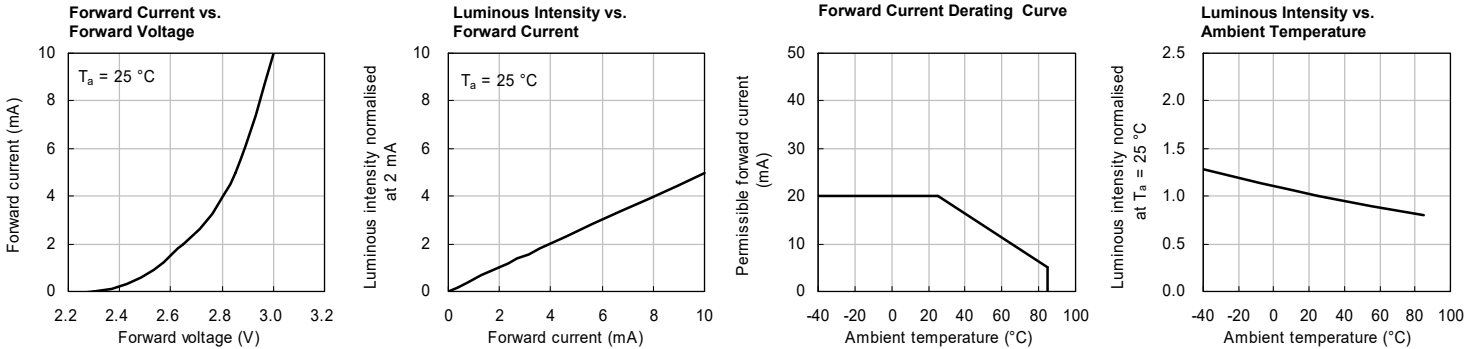
HYPER RED



BLUE

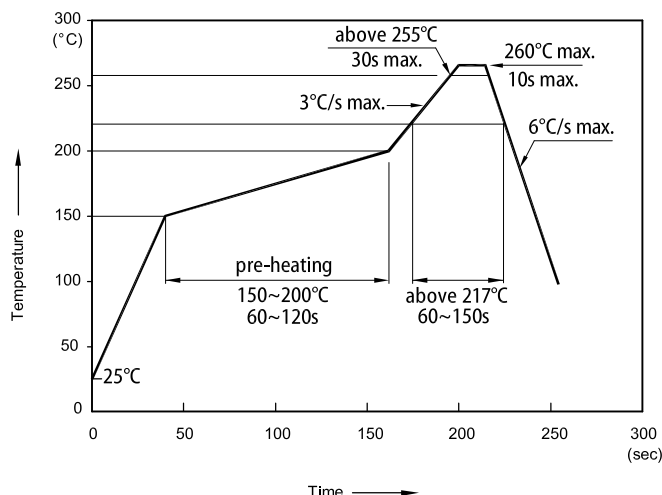


GREEN

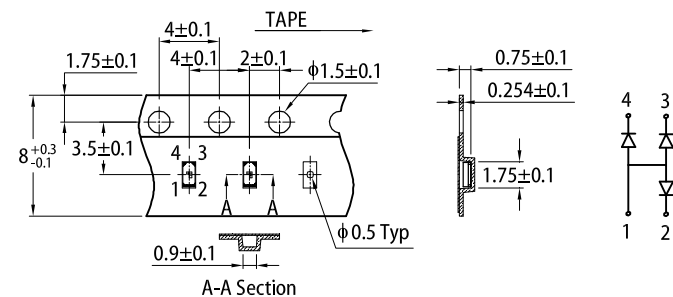


REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

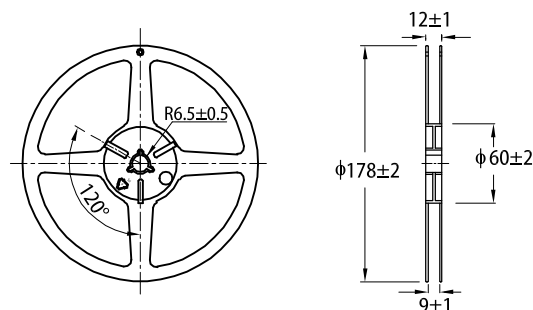
TAPE SPECIFICATIONS (units : mm)



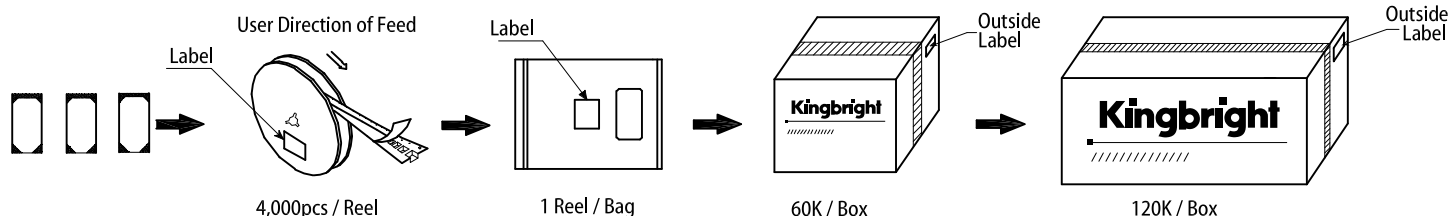
- Notes:
1. Don't cause stress to the LEDs while it is exposed to high temperature.
 2. The maximum number of reflow soldering passes is 2 times.
 3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.



REEL DIMENSION (units : mm)



PACKING & LABEL SPECIFICATIONS



PRECAUTIONARY NOTES

1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
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